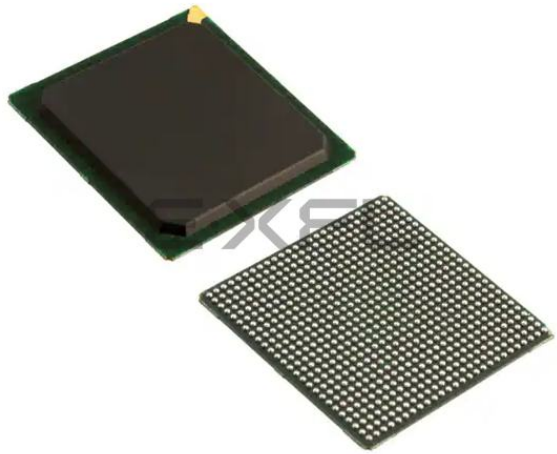

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	8064
Number of Logic Elements/Cells	-
Total RAM Bits	73728
Number of I/O	336
Number of Gates	500000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 85°C (TA)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ax500-1fgg676i

Thermal Characteristics

Introduction

The temperature variable in Microsemi's Designer software refers to the junction temperature, not the ambient temperature. This is an important distinction because dynamic and static power consumption cause the chip junction temperature to be higher than the ambient temperature. EQ 1 can be used to calculate junction temperature.

T_J = Junction Temperature = $\Delta T + T_a$

EQ 1

Where:

T_a = Ambient Temperature

ΔT = Temperature gradient between junction (silicon) and ambient

$\Delta T = \theta_{ja} * P$

EQ 2

Where:

P = Power

θ_{ja} = Junction to ambient of package. θ_{ja} numbers are located under Table 2-6 on page 2-7.

Package Thermal Characteristics

The device junction-to-case thermal characteristic is θ_{jc}, and the junction-to-ambient air characteristic is θ_{ja}. The thermal characteristics for θ_{ja} are shown with two different air flow rates. θ_{jc} values are provided for reference. The absolute maximum junction temperature is 125°C.

The maximum power dissipation allowed for commercial- and industrial-grade devices is a function of θ_{ja}. A sample calculation of the absolute maximum power dissipation allowed for an 896-pin FBGA package at commercial temperature and still air is as follows:

$$\text{Maximum Power Allowed} = \frac{\text{Max. junction temp. } (°C) - \text{Max. ambient temp. } (°C)}{\theta_{ja}(°C/W)} = \frac{125°C - 70°C}{13.6°C/W} = 4.04\ W$$

User I/Os[2]

Introduction

The Axcelerator family features a flexible I/O structure, supporting a range of mixed voltages (1.5 V, 1.8 V, 2.5 V, and 3.3 V) with its bank-selectable I/Os. Table 2-8 on page 2-12 contains the I/O standards supported by the Axcelerator family, and Table 2-10 on page 2-12 compares the features of the different I/O standards.

Each I/O provides programmable slew rates, drive strengths, and weak pull-up and weak pull-down circuits. The slew rate setting is effective for both rising and falling edges.

I/O standards, except 3.3 V PCI and 3.3 V PCI-X, are capable of hot insertion. 3.3 V PCI and 3.3 V PCI-X are 5 V tolerant with the aid of an external resistor.

The input buffer has an optional user-configurable delay element. The element can reduce or eliminate the hold time requirement for input signals registered within the I/O cell. The value for the delay is set on a bank-wide basis. Note that the delay WILL be a function of process variations as well as temperature and voltage changes.

Each I/O includes three registers: an input (InReg), an output (OutReg), and an enable register (EnReg). I/Os are organized into banks, and there are eight banks per device—two per side (Figure 2-6 on page 2-18). Each I/O bank has a common VCCI, the supply voltage for its I/Os.

For voltage-referenced I/Os, each bank also has a common reference-voltage bus, VREF. While VREF must have a common voltage for an entire I/O bank, its location is user-selectable. In other words, any user I/O in the bank can be selected to be a VREF.

The location of the VREF pin should be selected according to the following rules:

- Any pin that is assigned as a VREF can control a maximum of eight user I/O pad locations in each direction (16 total maximum) within the same I/O bank.
- I/O pad locations listed as no connects are counted as part of the 16 maximum. In many cases, this leads to fewer than eight user I/O package pins in each direction being controlled by a VREF pin.
- Dedicated I/O pins such as GND and VCCI are counted as part of the 16.
- The two user I/O pads immediately adjacent on each side of the VREF pin (four in total) may only be used as inputs. The exception is when there is a VCCI/GND pair separating the VREF pin and the user I/O pad location.
- The user does not need to assign VREF pins for OUTBUF and TRIBUF. VREF pins are needed only for input and bidirectional I/Os.

The differential amplifier supply voltage VCCDA should be connected to 3.3 V.

A user can gain access to the various I/O standards in three ways:

- Instantiate specific library macros that represent the desired specific standard.
- Use generic I/O macros and then use Designer's PinEditor to specify the desired I/O standards (please note that this is not applicable to differential standards).
- A combination of the first two methods.

Refer to the *I/O Features in Axcelerator Family Devices* application note and the *Antifuse Macro Library Guide* for more details.

2. *Do not use an external resister to pull the I/O above V_{CCI} for a higher logic "1" voltage level. The desired higher logic "1" voltage level will be degraded due to a small I/O current, which exists when the I/O is pulled up above V_{CCI}.*

I/O Clusters

Each I/O cluster incorporates two I/O modules, four RX modules, two TX modules, and a buffer module. In turn, each I/O module contains one Input Register (InReg), one Output Register (OutReg), and one Enable Register (EnReg) (Figure 2-5).

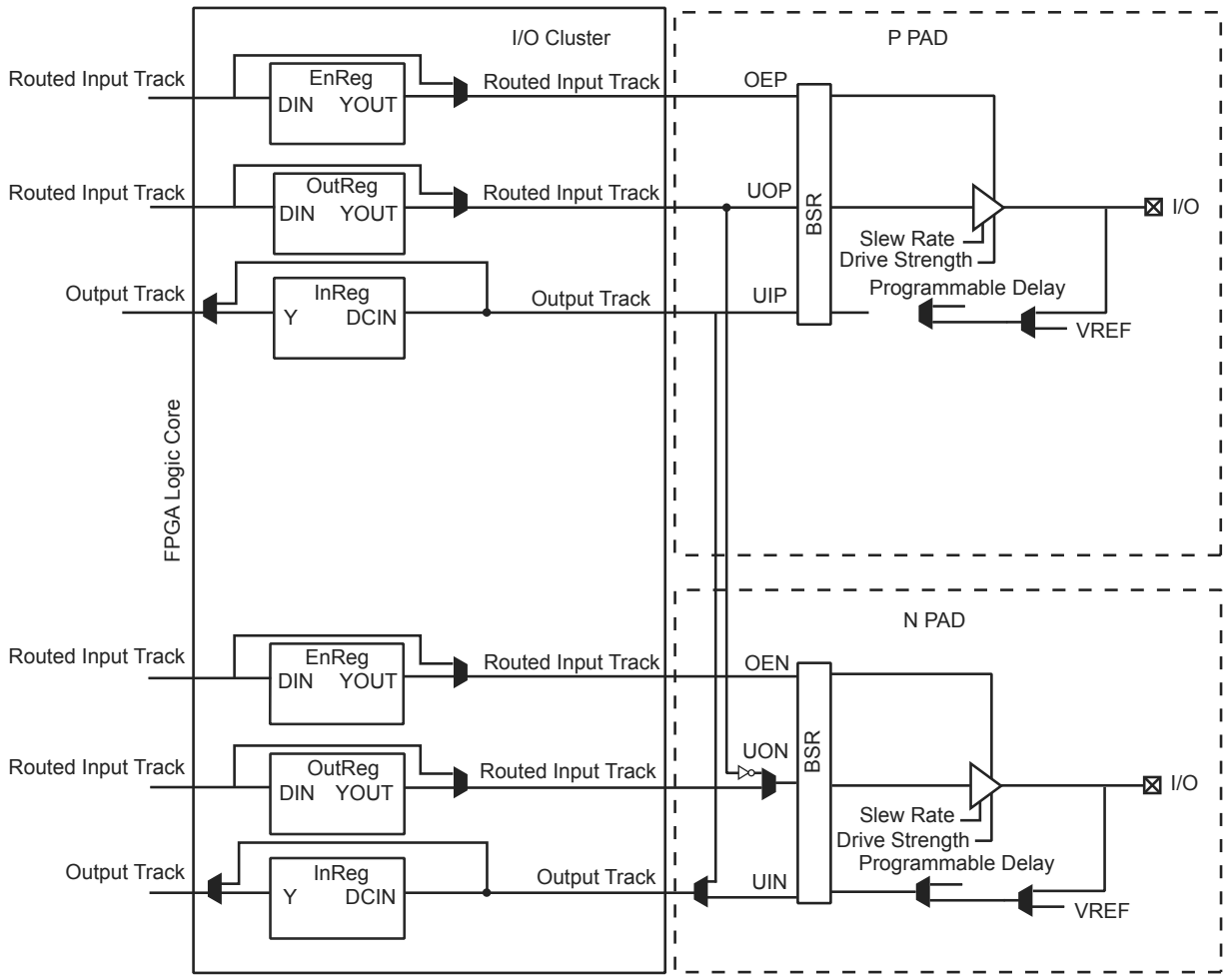

Figure 2-5 • **I/O Cluster Interface**

Using an I/O Register

To access the I/O registers, registers must be instantiated in the netlist and then connected to the I/Os. Usage of each I/O register (register combining) is individually controlled and can be selected/deselected using the PinEditor tool in the Designer software. I/O register combining can also be controlled at the device level, affecting all I/Os. Please note, the I/O register option is deselected by default in any given design.[4]

In addition, Designer software provides a global option to enable/disable the usage of registers in the I/Os. This option is design-specific. The setting for each individual I/O overrides this global option. Furthermore, the *global set fuse* option in the Designer software, when checked, causes all I/O registers to output logic High at device power-up.

4. Please note that register combining for multi fanout nets is not supported.

Using the Differential I/O Standards

Differential I/O macros should be instantiated in the netlist. The settings for these I/O standards cannot be changed inside Designer. Note that there are no tristated or bidirectional I/O buffers for differential standards.

Using the Voltage-Referenced I/O Standards

Using these I/O standards is similar to that of single-ended I/O standards. Their settings can be changed in Designer.

Using DDR (Double Data Rate)

In Double Data Rate mode, new data is present on every transition of the clock signal. Clock and data lines have identical bandwidth and signal integrity requirements, making it very efficient for implementing very high-speed systems.

To implement a DDR, users need to:

1. Instantiate an input buffer (with the required I/O standard)
2. Instantiate the DDR_REG macro (Figure 2-6)
3. Connect the output from the Input buffer to the input of the DDR macro

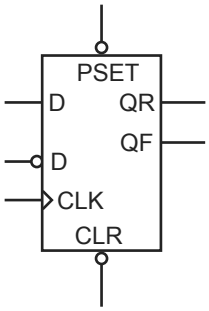

Figure 2-6 • **DDR Register**

Macros for Specific I/O Standards

There are different macro types for any I/O standard or feature that determine the required VCCI and VREF voltages for an I/O. The generic buffer macros require the LVTTL standard with slow slew rate and 24 mA-drive strength. LVTTL can support high slew rate but this should only be used for critical signals.

Most of the macro symbols represent variations of the six generic symbol types:

- CLKBUF: Clock Buffer
- HCLKBUF: Hardwired Clock Buffer
- INBUF: Input Buffer
- OUTBUF: Output Buffer
- TRIBUF: Tristate Buffer
- BIBUF: Bidirectional Buffer

Other macros include the following:

- Differential I/O standard macros: The LVDS and LVPECL macros either have a pair of differential inputs (e.g. INBUF_LVDS) or a pair of differential outputs (e.g. OUTBUF_LVPECL).
- Pull-up and pull-down variations of the INBUF, BIBUF, and TRIBUF macros. These are available only with TTL and LVCMOS thresholds. They can be used to model the behavior of the pull-up and pull-down resistors available in the architecture. Whenever an input pin is left unconnected, the output pin will either go high or low rather than unknown. This allows users to leave inputs unconnected without having the negative effect on simulation of propagating unknowns.
- DDR_REG macro. It can be connected to any I/O standard input buffers (i.e. INBUF) to implement a double data rate register. Designer software will map it to the I/O module in the same way it maps the other registers to the I/O module.

***Table 2-22* • 3.3 V LVTTL I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C (continued)

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
LVTTL Output Drive Strength = 4 (24mA) / High Slew Rate								
t_{DP}	Input Buffer		1.68		1.92		2.26	ns
t_{PY}	Output Buffer		2.99		3.41		4.01	ns
t_{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		2.49		2.51		2.51	ns
t_{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		2.59		2.95		3.46	ns
t_{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		1.91		1.93		1.93	ns
t_{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		3.56		4.06		4.77	ns
t_{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t_{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Timing Characteristics

***Table 2-35* • 3.3 V PCI I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
3.3 V PCI Output Module Timing								
t_{DP}	Input Buffer		1.57		1.79		2.10	ns
t_{PY}	Output Buffer		1.91		2.18		2.56	ns
t_{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		1.61		1.62		1.63	ns
t_{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		1.45		1.47		1.47	ns
t_{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		2.55		2.90		3.41	ns
t_{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		3.52		4.01		4.72	ns
t_{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t_{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

LVPECL

Low-Voltage Positive Emitter-Coupled Logic (LVPECL) is another differential I/O standard. It requires that one data bit is carried through two signal lines. Like LVDS, two pins are needed. It also requires external resistor termination. The voltage swing between these two signal lines is approximately 850 mV.

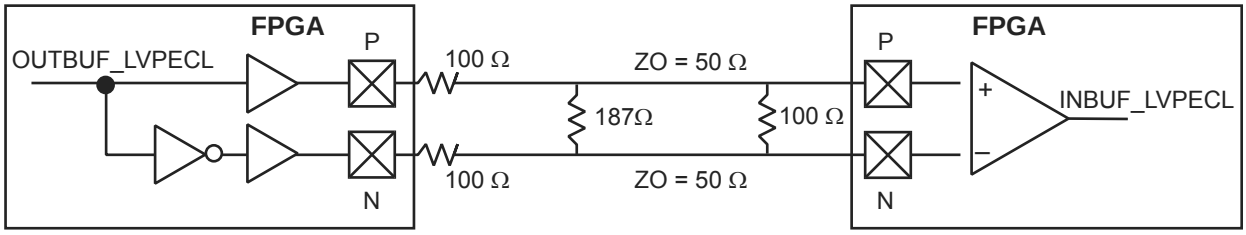

Figure 2-26 • **LVPECL Board-Level Implementation**

The LVPECL circuit is similar to the LVDS scheme. It requires four external resistors, three for the driver and one for the receiver. The values for the three driver resistors are different from that of LVDS since the output voltage levels are different. Please note that the VOH levels are 200 mV below the standard LVPECL levels.

Table 2-59 • **DC Input and Output Levels**

	Min.		Typ.		Max.		
DC Parameter	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
VCCI	3		3.3		3.6		V
VOH	1.8	2.11	1.92	2.28	2.13	2.41	V
VOL	0.96	1.27	1.06	1.43	1.3	1.57	V
VIH	1.49	2.72	1.49	2.72	1.49	2.72	V
VIL	0.86	2.125	0.86	2.125	0.86	2.125	V
Differential Input Voltage	0.3		0.3		0.3		V

Table 2-60 • **AC Waveforms, Measuring Points, and Capacitive Loads**

Input Low (V)	Input High (V)	Measuring Point* (V)
1.6 – 0.3	1.6 + 0.3	1.6

*Note: * Measuring Point = VTRIP*

***Table 2-67* • AX500 Predicted Routing Delays**
Worst-Case Commercial Conditions VCCA = 1.425 V, T_J = 70°C

		–2 Speed	–1 Speed	Std Speed	
Parameter	**Description**	**Typical**	**Typical**	**Typical**	**Units**
Predicted Routing Delays					
t_{DC}	DirectConnect Routing Delay, FO1	0.11	0.12	0.15	ns
t_{FC}	FastConnect Routing Delay, FO1	0.35	0.39	0.46	ns
t_{RD1}	Routing delay for FO1	0.39	0.45	0.53	ns
t_{RD2}	Routing delay for FO2	0.41	0.46	0.54	ns
t_{RD3}	Routing delay for FO3	0.48	0.55	0.64	ns
t_{RD4}	Routing delay for FO4	0.56	0.63	0.75	ns
t_{RD5}	Routing delay for FO5	0.60	0.68	0.80	ns
t_{RD6}	Routing delay for FO6	0.84	0.96	1.13	ns
t_{RD7}	Routing delay for FO7	0.90	1.02	1.20	ns
t_{RD8}	Routing delay for FO8	1.00	1.13	1.33	ns
t_{RD16}	Routing delay for FO16	2.17	2.46	2.89	ns
t_{RD32}	Routing delay for FO32	3.55	4.03	4.74	ns

***Table 2-68* • AX1000 Predicted Routing Delays**
Worst-Case Commercial Conditions VCCA = 1.425 V, T_J = 70°C

		–2 Speed	–1 Speed	Std Speed	
Parameter	**Description**	**Typical**	**Typical**	**Typical**	**Units**
Predicted Routing Delays					
t_{DC}	DirectConnect Routing Delay, FO1	0.12	0.13	0.15	ns
t_{FC}	FastConnect Routing Delay, FO1	0.35	0.39	0.46	ns
t_{RD1}	Routing delay for FO1	0.45	0.51	0.60	ns
t_{RD2}	Routing delay for FO2	0.53	0.60	0.71	ns
t_{RD3}	Routing delay for FO3	0.56	0.63	0.74	ns
t_{RD4}	Routing delay for FO4	0.63	0.71	0.84	ns
t_{RD5}	Routing delay for FO5	0.73	0.82	0.97	ns
t_{RD6}	Routing delay for FO6	0.99	1.13	1.32	ns
t_{RD7}	Routing delay for FO7	1.02	1.15	1.36	ns
t_{RD8}	Routing delay for FO8	1.48	1.68	1.97	ns
t_{RD16}	Routing delay for FO16	2.57	2.91	3.42	ns
t_{RD32}	Routing delay for FO32	4.24	4.81	5.65	ns

Axcelerator Clock Management System

Introduction

Each member of the Axcelerator family[6] contains eight phase-locked loop (PLL) blocks which perform the following functions:

- Programmable Delay (32 steps of 250 ps)
- Clock Skew Minimization
- Clock Frequency Synthesis

Each PLL has the following key features:

- Input Frequency Range – 14 to 200 MHz
- Output Frequency Range – 20 MHz to 1 GHz
- Output Duty Cycle Range – 45% to 55%
- Maximum Long-Term Jitter – 1% or 100ps (whichever is greater)
- Maximum Short-Term Jitter – 50ps + 1% of Output Frequency
- Maximum Acquisition Time (lock) – 20µs

Physical Implementation

The eight PLL blocks are arranged in two groups of four. One group is located in the center of the northern edge of the chip, while the second group is centered on the southern edge. The northern group is associated with the four HCLK networks (e.g. PLLA can drive HCLKA), while the southern group is associated with the four CLK networks (e.g. PLLE can drive CLKE).

Each PLL cell is connected to two I/O pads and a PLL Cluster that interfaces with the FPGA core. Figure 2-48 illustrates a PLL block. The VCCPLL pin should be connected to a 1.5V power supply through a 250 Ω resistor. Furthermore, 0.1 µF and 10 µF decoupling capacitors should be connected across the VCCPLL and VCOMPPLL pins.

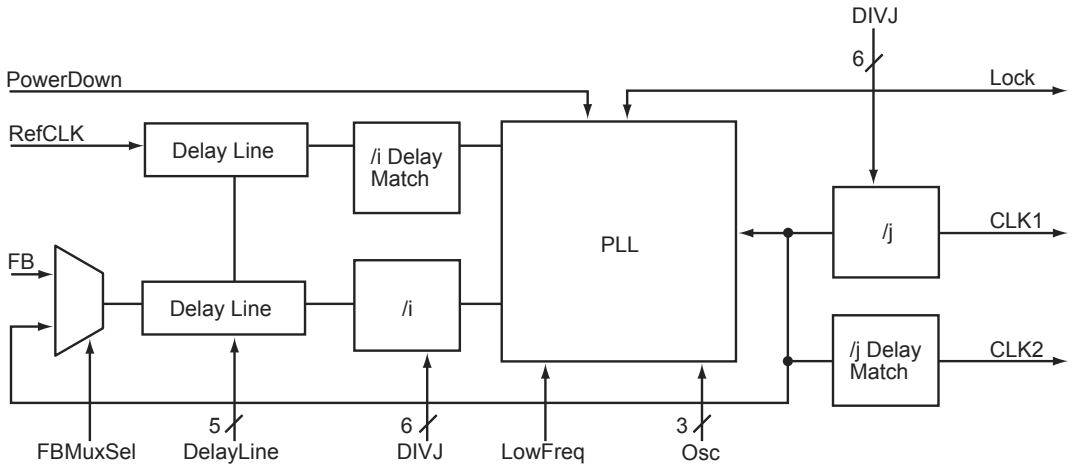

Figure 2-48 • **PLL Block Diagram**

Note: The VCOMPPLL pin should never be grounded (Figure 2-2 on page 2-9)!

The I/O pads associated with the PLL can also be configured for regular I/O functions except when it is used as a clock buffer. The I/O pads can be configured in all the modes available to the regular I/O pads in the same I/O bank. In particular, the [H]CLKxP pad can be configured as a differential pair,

6. *AX2000-CQ256 does not support operation of the phase-locked loops. This is in order to support full pin compatibility with RTAX2000S/SL-CQ256.*

***Table 2-83* • South PLL Connections**

CLK1	CLK2
CLK1	Routed net
CLK1	Unused
CLK2	CLK1
CLK2	Routed net
CLK2	Both CLK1 and routed net
CLK2	Unused
Unused	CLK1
Unused	Routed net
Unused	Both CLK1 and routed net
Unused	Unused
Routed net	CLK1
Routed net	Unused
Both CLK1 and CLK2	Routed net
Both CLK1 and CLK2	Unused
Both CLK1 and routed net	Unusable
Both CLK2 and routed net	CLK1
Both CLK2 and routed net	Unused
CLK1, CLK2, and routed net	Unusable

Note: Designer software currently does not support all of these connections. Only exclusive connections where one output connects to a single net are supported at this time (e.g., CLK1 driving both CLK1 and CLK2 is not supported).

BG729	
AX1000 Function	Pin Number
IO163PB5F15	AA14
IO164NB5F15	AE13
IO164PB5F15	AF13
IO165NB5F15	AF12
IO165PB5F15	AG12
IO166NB5F15	AD12
IO166PB5F15	AE12
IO167NB5F15	Y13
IO167PB5F15	AA13
IO168NB5F15	AD11
IO168PB5F15	AE11
IO169NB5F15	AG11
IO169PB5F15	AF11
IO170NB5F15	AB11
IO170PB5F15	AC11
IO171NB5F16	AF10
IO171PB5F16	AG10
IO172NB5F16	AD10
IO172PB5F16	AE10
IO173NB5F16	Y12
IO173PB5F16	AA12
IO174NB5F16	AB10
IO174PB5F16	AC10
IO175NB5F16	AF9
IO175PB5F16	AG9
IO176NB5F16	AD9
IO176PB5F16	AE9
IO177NB5F16	Y11
IO177PB5F16	AA11
IO178NB5F16	AF8
IO178PB5F16	AG8
IO179NB5F16	AD8
IO179PB5F16	AE8
IO180NB5F16	AB9
IO180PB5F16	AC9
IO181NB5F17	Y10
IO181PB5F17	AA10

BG729	
AX1000 Function	Pin Number
IO182NB5F17	AF7
IO182PB5F17	AG7
IO183NB5F17	AD7
IO183PB5F17	AE7
IO184NB5F17	AC7
IO184PB5F17	AC8
IO185NB5F17	AF6
IO185PB5F17	AG6
IO186NB5F17	AB7
IO186PB5F17	AB8
IO187NB5F17	Y9
IO187PB5F17	AA9
IO188NB5F17	AD6
IO188PB5F17	AE6
IO189NB5F17	AB6
IO189PB5F17	AC6
IO190NB5F17	AF5
IO190PB5F17	AG5
IO191NB5F17	AA6
IO191PB5F17	AA7
IO192NB5F17	Y8
IO192PB5F17	AA8
Bank 6	
IO193NB6F18	W8
IO193PB6F18	Y7
IO194NB6F18	AB5
IO194PB6F18	AC5
IO195NB6F18	AC2
IO195PB6F18	AC3
IO196NB6F18	AC4
IO196PB6F18	AD4
IO197NB6F18	Y5
IO197PB6F18	Y6
IO198NB6F18	AB3
IO198PB6F18	AB4
IO199NB6F18	V7
IO199PB6F18	W7

BG729	
AX1000 Function	Pin Number
IO200NB6F18	AA4
IO200PB6F18	AA5
IO201NB6F18	W5
IO201PB6F18	W6
IO202NB6F18	AB1
IO202PB6F18	AC1
IO203NB6F19	Y3
IO203PB6F19	AA3
IO204NB6F19	AA2
IO204PB6F19	AB2
IO205NB6F19	U8
IO205PB6F19	V8
IO206NB6F19	V5
IO206PB6F19	V6
IO207NB6F19	Y1
IO207PB6F19	AA1
IO208NB6F19	W4
IO208PB6F19	Y4
IO209NB6F19	T7
IO209PB6F19	U7
IO210NB6F19	W2
IO210PB6F19	Y2
IO211NB6F19	U5
IO211PB6F19	U6
IO212NB6F19	V3
IO212PB6F19	W3
IO213NB6F19	R9
IO213PB6F19	T8
IO214NB6F20	U4
IO214PB6F20	V4
IO215NB6F20	T5
IO215PB6F20	T6
IO216NB6F20	V1
IO216PB6F20	W1
IO217NB6F20	R7
IO217PB6F20	R8
IO218NB6F20	U2

FG324	
AX125 Function	**Pin Number**
IO50NB4F4/CLKFN	U9
IO50PB4F4/CLKFP	U10
Bank 5	
IO51NB5F5/CLKGN	R8
IO51PB5F5/CLKGP	R9
IO52NB5F5/CLKHN	T7
IO52PB5F5/CLKHP	T8
IO53NB5F5	U6
IO53PB5F5	U7
IO54NB5F5	V8
IO54PB5F5	V9
IO55NB5F5	V6
IO55PB5F5	V7
IO56NB5F5	U4
IO56PB5F5	U5
IO57NB5F5	T4
IO57PB5F5	T5
IO58NB5F5	V4
IO58PB5F5	V5
IO59NB5F5	V2
IO59PB5F5	V3
Bank 6	
IO60NB6F6	P5
IO60PB6F6	P6
IO61NB6F6	T2
IO61PB6F6	U3
IO62NB6F6	T1
IO62PB6F6	U1
IO63NB6F6	P1
IO63PB6F6	R1
IO64NB6F6	R3
IO64PB6F6	P3
IO65NB6F6	P2
IO65PB6F6	R2
IO66NB6F6	M3

FG324	
AX125 Function	**Pin Number**
IO66PB6F6	N3
IO67NB6F6	M2
IO67PB6F6	N2
IO68NB6F6	M1
IO68PB6F6	N1
IO69NB6F6	K4
IO69PB6F6	L4
IO70NB6F6	K1
IO70PB6F6	L1
IO71NB6F6	K3
IO71PB6F6	L3
Bank 7	
IO72NB7F7	H4
IO72PB7F7	J4
IO73NB7F7	K2
IO73PB7F7	L2
IO74NB7F7	H2
IO74PB7F7	H1
IO75NB7F7	H3
IO75PB7F7	J3
IO76NB7F7	F2
IO76PB7F7	G2
IO77NB7F7	F1
IO77PB7F7	G1
IO78NB7F7	D2
IO78PB7F7	E2
IO79NB7F7	F3
IO79PB7F7	G3
IO80NB7F7	E3
IO80PB7F7	E4
IO81NB7F7	D1
IO81PB7F7	E1
IO82NB7F7	D3
IO82PB7F7	C2
IO83NB7F7	B1

FG324	
AX125 Function	**Pin Number**
IO83PB7F7	C1
Dedicated I/O	
VCCDA	F5
GND	A1
GND	A18
GND	B17
GND	B2
GND	C16
GND	C3
GND	E16
GND	F13
GND	F6
GND	G12
GND	G7
GND	H10
GND	H11
GND	H8
GND	H9
GND	J10
GND	J11
GND	J8
GND	J9
GND	K10
GND	K11
GND	K8
GND	K9
GND	L10
GND	L11
GND	L8
GND	L9
GND	M12
GND	M7
GND	N13
GND	N6
GND	R14

FG484	
AX1000 Function	**Pin Number**
IO87PB2F8	H20
IO88NB2F8	L18
IO88PB2F8	K18
IO89NB2F8	K19
IO89PB2F8	J19
IO90NB2F8	J21
IO90PB2F8	H21
IO91NB2F8	J22
IO91PB2F8	H22
IO93NB2F8	K21
IO93PB2F8	K22
IO94NB2F8	L20
IO94PB2F8	K20
IO95NB2F8	M21
IO95PB2F8	L21
Bank 3	
IO96NB3F9	N16
IO96PB3F9	M16
IO97NB3F9	M19
IO97PB3F9	L19
IO98NB3F9	P22
IO98PB3F9	N22
IO99NB3F9	N20
IO99PB3F9	M20
IO100NB3F9	N17
IO100PB3F9	M17
IO101NB3F9	P21
IO101PB3F9	N21
IO103NB3F9	R20
IO103PB3F9	P20
IO104NB3F9	N18
IO104PB3F9	N19
IO105NB3F9	T22
IO105PB3F9	R22
IO106NB3F9	R17

FG484	
AX1000 Function	**Pin Number**
IO106PB3F9	P17
IO107NB3F10	T21
IO107PB3F10	R21
IO110NB3F10	V22
IO110PB3F10	U22
IO113NB3F10	V21
IO113PB3F10	U21
IO114NB3F10	P18
IO114PB3F10	P19
IO116PB3F10	R19
IO117NB3F10	U20
IO117PB3F10	T20
IO118NB3F11	T18
IO118PB3F11	R18
IO121NB3F11	U19
IO121PB3F11	T19
IO124NB3F11	R16
IO124PB3F11	P16
IO127NB3F11	W21
IO127PB3F11	W22
Bank 4	
IO129PB4F12	AB17
IO132NB4F12	Y19
IO132PB4F12	W18
IO133NB4F12	W17
IO133PB4F12	V17
IO135NB4F12	T15
IO135PB4F12	T16
IO138NB4F12	Y17
IO138PB4F12	Y18
IO139NB4F13	V15
IO139PB4F13	V16
IO140NB4F13	U18
IO140PB4F13	V19
IO142NB4F13	W20

FG484	
AX1000 Function	**Pin Number**
IO142PB4F13	V20
IO143NB4F13	W15
IO143PB4F13	W16
IO144NB4F13	AA18
IO144PB4F13	AA19
IO145NB4F13	U14
IO145PB4F13	U15
IO146NB4F13	Y15
IO146PB4F13	Y16
IO147NB4F13	AB18
IO147PB4F13	AB19
IO149NB4F13	Y14
IO149PB4F13	W14
IO150NB4F13	AA16
IO150PB4F13	AA17
IO152NB4F14	AA14
IO152PB4F14	AA15
IO154NB4F14	AB14
IO154PB4F14	AB15
IO155NB4F14	AA13
IO155PB4F14	AB13
IO158NB4F14	Y12
IO158PB4F14	Y13
IO159NB4F14/CLKEN	V12
IO159PB4F14/CLKEP	V13
IO160NB4F14/CLKFN	W11
IO160PB4F14/CLKFP	W12
Bank 5	
IO161NB5F15/CLKGN	U10
IO161PB5F15/CLKGP	U11
IO162NB5F15/CLKHN	V9
IO162PB5F15/CLKHP	V10
IO163NB5F15	Y10
IO163PB5F15	Y11
IO167NB5F15	AA11

FG676	
AX500 Function	Pin Number
IO51NB2F4	L20
IO51PB2F4	L21
IO52NB2F5	K26
IO52PB2F5	J26
IO53NB2F5	L23
IO53PB2F5	L22
IO54NB2F5	L24
IO54PB2F5	K24
IO55NB2F5	M20
IO55PB2F5	M21
IO56NB2F5	L26
IO56PB2F5	L25
IO57NB2F5	M23
IO57PB2F5	M22
IO58NB2F5	M26
IO58PB2F5	M25
IO59NB2F5	N22
IO59PB2F5	N23
IO60NB2F5	N24
IO60PB2F5	M24
IO61NB2F5	N20
IO61PB2F5	N21
IO62NB2F5	P25
IO62PB2F5	N25
Bank 3	
IO63NB3F6	T26
IO63PB3F6	R26
IO64NB3F6	R24
IO64PB3F6	P24
IO65NB3F6	P20
IO65PB3F6	P21
IO66NB3F6	T25
IO66PB3F6	R25
IO67NB3F6	T23
IO67PB3F6	R23

FG676	
AX500 Function	Pin Number
IO68NB3F6	V26
IO68PB3F6	U26
IO69NB3F6	V25
IO69PB3F6	U25
IO70NB3F6	Y25
IO70PB3F6	W25
IO71NB3F6	W24
IO71PB3F6	V24
IO72NB3F6	V23
IO72PB3F6	U23
IO73NB3F6	T21
IO73PB3F6	T20
IO74NB3F7	AA26
IO74PB3F7	Y26
IO75NB3F7	AA24
IO75PB3F7	Y24
IO76NB3F7	Y23
IO76PB3F7	W23
IO77NB3F7	V21
IO77PB3F7	U21
IO78NB3F7	AB25
IO78PB3F7	AA25
IO79NB3F7	AC26
IO79PB3F7	AB26
IO80NB3F7	AC24
IO80PB3F7	AB24
IO81NB3F7	AB23
IO81PB3F7	AA23
IO82NB3F7	AA22
IO82PB3F7	Y22
IO83NB3F7	AE26
IO83PB3F7	AD26
Bank 4	
IO84NB4F8	AB21
IO84PB4F8	AA21

FG676	
AX500 Function	Pin Number
IO85NB4F8	AE23
IO85PB4F8	AE24
IO86NB4F8	AC21
IO86PB4F8	AC22
IO87NB4F8	AF22
IO87PB4F8	AF23
IO88NB4F8	AD22
IO88PB4F8	AD23
IO89NB4F8	AC19
IO89PB4F8	AC20
IO90NB4F8	AE21
IO90PB4F8	AE22
IO91NB4F8	AA17
IO91PB4F8	AA18
IO92NB4F8	AD20
IO92PB4F8	AD21
IO93NB4F8	AF20
IO93PB4F8	AF21
IO94NB4F9	AE19
IO94PB4F9	AE20
IO95NB4F9	AC17
IO95PB4F9	AC18
IO96NB4F9	AD18
IO96PB4F9	AD19
IO97NB4F9	AA16
IO97PB4F9	Y16
IO98NB4F9	AE17
IO98PB4F9	AE18
IO99NB4F9	AC16
IO99PB4F9	AB16
IO100NB4F9	AF17
IO100PB4F9	AF18
IO101NB4F9	AA15
IO101PB4F9	Y15
IO102NB4F9	AC15

FG676	
AX500 Function	Pin Number
IO102PB4F9	AB15
IO103NB4F9/CLKEN	AE16
IO103PB4F9/CLKEP	AF16
IO104NB4F9/CLKFN	AE14
IO104PB4F9/CLKFP	AE15
Bank 5	
IO105NB5F10/CLKGN	AE12
IO105PB5F10/CLKGP	AE13
IO106NB5F10/CLKHN	AE11
IO106PB5F10/CLKHP	AF11
IO107NB5F10	Y12
IO107PB5F10	AA13
IO108NB5F10	AC12
IO108PB5F10	AB12
IO109NB5F10	AC10
IO109PB5F10	AC11
IO110NB5F10	AF9
IO110PB5F10	AF10
IO111NB5F10	Y11
IO111PB5F10	AA12
IO112NB5F10	AE9
IO112PB5F10	AE10
IO113NB5F10	AC9
IO113PB5F10	AD9
IO114NB5F11	AF6
IO114PB5F11	AF7
IO115NB5F11	AA10
IO115PB5F11	AB10
IO116NB5F11	AE7
IO116PB5F11	AE8
IO117NB5F11	AD7
IO117PB5F11	AD8
IO118NB5F11	AC7
IO118PB5F11	AC8
IO119NB5F11	AD6

FG676	
AX500 Function	Pin Number
IO119PB5F11	AE6
IO120NB5F11	AE5
IO120PB5F11	AF5
IO121NB5F11	AF4
IO121PB5F11	AE4
IO122NB5F11	AC5
IO122PB5F11	AC6
IO123NB5F11	AD4
IO123PB5F11	AD5
IO124NB5F11	AB6
IO124PB5F11	AB7
IO125NB5F11	AE3
IO125PB5F11	AF3
Bank 6	
IO126NB6F12	AB3
IO126PB6F12	AC3
IO127NB6F12	AA2
IO127PB6F12	AB2
IO128NB6F12	AC2
IO128PB6F12	AD2
IO129NB6F12	Y1
IO129PB6F12	AA1
IO130NB6F12	Y3
IO130PB6F12	AA3
IO131NB6F12	U6
IO131PB6F12	V6
IO132NB6F12	W2
IO132PB6F12	Y2
IO133NB6F12	V4
IO133PB6F12	W4
IO134NB6F12	V3
IO134PB6F12	W3
IO135NB6F12	V1
IO135PB6F12	V2
IO136NB6F13	U4

FG676	
AX500 Function	Pin Number
IO136PB6F13	U5
IO137NB6F13	T6
IO137PB6F13	T7
IO138NB6F13	T5
IO138PB6F13	T4
IO139NB6F13	R6
IO139PB6F13	R7
IO140NB6F13	T3
IO140PB6F13	U3
IO141NB6F13	U1
IO141PB6F13	U2
IO142NB6F13	R2
IO142PB6F13	T2
IO143NB6F13	P3
IO143PB6F13	R3
IO144NB6F13	P5
IO144PB6F13	P4
IO145NB6F13	P6
IO145PB6F13	P7
IO146NB6F13	R1
IO146PB6F13	T1
Bank 7	
IO147NB7F14	N6
IO147PB7F14	N7
IO148NB7F14	N5
IO148PB7F14	N4
IO149NB7F14	N2
IO149PB7F14	N3
IO150NB7F14	L1
IO150PB7F14	M1
IO151NB7F14	M2
IO151PB7F14	M3
IO152NB7F14	M5
IO152PB7F14	M4
IO153NB7F14	M7

FG676	
AX500 Function	**Pin Number**
IO153PB7F14	M6
IO154NB7F14	K2
IO154PB7F14	L2
IO155NB7F14	K3
IO155PB7F14	L3
IO156NB7F14	L5
IO156PB7F14	L4
IO157NB7F14	L6
IO157PB7F14	L7
IO158NB7F15	J1
IO158PB7F15	K1
IO159NB7F15	J4
IO159PB7F15	K4
IO160NB7F15	H2
IO160PB7F15	J2
IO161NB7F15	K6
IO161PB7F15	K5
IO162NB7F15	H3
IO162PB7F15	J3
IO163NB7F15	G2
IO163PB7F15	G1
IO164NB7F15	G4
IO164PB7F15	H4
IO165NB7F15	F3
IO165PB7F15	G3
IO166NB7F15	E2
IO166PB7F15	F2
IO167NB7F15	F5
IO167PB7F15	G5
Dedicated I/O	
GND	A1
GND	A13
GND	A14
GND	A19
GND	A26

FG676	
AX500 Function	**Pin Number**
GND	A8
GND	AC23
GND	AC4
GND	AD24
GND	AD3
GND	AE2
GND	AE25
GND	AF1
GND	AF13
GND	AF14
GND	AF19
GND	AF26
GND	AF8
GND	B2
GND	B25
GND	B26
GND	C24
GND	C3
GND	G20
GND	G7
GND	H1
GND	H19
GND	H26
GND	H8
GND	J18
GND	J9
GND	K10
GND	K11
GND	K12
GND	K13
GND	K14
GND	K15
GND	K16
GND	K17
GND	L10

FG676	
AX500 Function	**Pin Number**
GND	L11
GND	L12
GND	L13
GND	L14
GND	L15
GND	L16
GND	L17
GND	M10
GND	M11
GND	M12
GND	M13
GND	M14
GND	M15
GND	M16
GND	M17
GND	N1
GND	N10
GND	N11
GND	N12
GND	N13
GND	N14
GND	N15
GND	N16
GND	N17
GND	N26
GND	P1
GND	P10
GND	P11
GND	P12
GND	P13
GND	P14
GND	P15
GND	P16
GND	P17
GND	P26

FG896	
AX2000 Function	Pin Number
IO124NB2F11	P29
IO124PB2F11	P30
IO125NB2F11	R22
IO125PB2F11	R23
IO127NB2F11	R24
IO127PB2F11	R25
IO128NB2F11	R29
IO128PB2F11	R30
Bank 3	
IO129NB3F12	T27
IO129PB3F12	R27
IO130NB3F12	T29
IO130PB3F12	T30
IO131NB3F12	T22
IO131PB3F12	T23
IO132NB3F12	U26
IO132PB3F12	T26
IO133NB3F12	U24
IO133PB3F12	T24
IO135NB3F12	U23
IO135PB3F12	U22
IO136NB3F12	U29
IO136PB3F12	U30
IO137NB3F12	V28
IO137PB3F12	U28
IO138NB3F12	V27
IO138PB3F12	U27
IO139NB3F13	V25
IO139PB3F13	U25
IO141NB3F13	V23
IO141PB3F13	V22
IO142NB3F13	W29
IO142PB3F13	V29
IO143NB3F13	W26
IO143PB3F13	V26

FG896	
AX2000 Function	Pin Number
IO145NB3F13	W24
IO145PB3F13	V24
IO146NB3F13	W27
IO146PB3F13	W28
IO147NB3F13	Y28
IO147PB3F13	Y27
IO148NB3F13	Y30
IO148PB3F13	W30
IO149NB3F13	Y25
IO149PB3F13	W25
IO150NB3F14	AA29
IO150PB3F14	Y29
IO151NB3F14	AC29
IO152NB3F14	AA26
IO152PB3F14	Y26
IO153NB3F14	Y23
IO153PB3F14	W23
IO154NB3F14	AB30
IO154PB3F14	AA30
IO155NB3F14	AB27
IO155PB3F14	AA27
IO156NB3F14	AC28
IO156PB3F14	AB28
IO157NB3F14	AA24
IO157PB3F14	Y24
IO158NB3F14	AF29
IO158PB3F14	AF30
IO159NB3F14	AB25
IO159PB3F14	AA25
IO160NB3F14	AE30
IO160PB3F14	AD30
IO161NB3F15	AE29
IO161PB3F15	AD29
IO162NB3F15	AD27
IO162PB3F15	AC27

FG896	
AX2000 Function	Pin Number
IO163NB3F15	AC26
IO163PB3F15	AB26
IO164NB3F15	AE28
IO164PB3F15	AD28
IO165NB3F15	AC24
IO165PB3F15	AB24
IO166NB3F15	AG28
IO166PB3F15	AF28
IO167NB3F15	AE26
IO167PB3F15	AD26
IO168NB3F15	AD25
IO168PB3F15	AC25
IO169NB3F15	AF27
IO169PB3F15	AE27
IO170NB3F15	AB23
IO170PB3F15	AA23
Bank 4	
IO171NB4F16	AG29
IO171PB4F16	AG30
IO172NB4F16	AF24
IO172PB4F16	AF25
IO173NB4F16	AG25
IO173PB4F16	AG26
IO174NB4F16	AJ25
IO174PB4F16	AJ26
IO175NB4F16	AK26
IO175PB4F16	AK27
IO176NB4F16	AE23
IO176PB4F16	AE24
IO177NB4F16	AH24
IO177PB4F16	AH25
IO178NB4F16	AD23
IO178PB4F16	AC23
IO179PB4F16	AJ27
IO180NB4F16	AG23

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